









Release Date: 01 February 2025 Version: A1.1

# PRODUCT DATASHEET



- ► Ceramic High Power
- ➤ 3535 3.60t Series
- ➤ Yellow (585-595nm)

N0Y56S89



# 3535 3.60t Series





#### **FEATURES:**

Package: Ceramic SMT Package with Silicon Lens

Forward Current: 350~700mA Forward Voltage (typ.): 2.2V

Luminous Flux (typ.): 60lm@350mA

Colour: Yellow

Dominant Wavelength: 585~595nm

Viewing Angle: 30°

**Materials:** 

Resin: Silicon (Water Clear)

L/T Finish: Au plated

Operating Temperature: -40~+85°C

Storage Temperature: -40~+100°C

**Grouping Parameters:** 

Forward Voltage

Luminous Flux

**Dominant Wavelength** 

Soldering Methods: Reflow Soldering

MSL Level: according to J-STD020 MSL 4

Packing: 12mm tape with max.500pcs/reel, ø180mm (7")

3535 3.60t Series

## **APPLICATIONS:**

- Portable Lighting
- **Outdoor Lighting**
- Commercial Lighting
- **Indoor Lighting**
- **Industrial Lighting**
- Plant Grow Light



## **CHARACTERISTICS:**

# Absolute Maximum Characteristics (T<sub>a</sub>=25°C)

Parameter	Symbol	Ratings	Unit
DC Forward Current	IF	700	mA
Pulse Forward Current	IPF	1000	mA
Reverse Voltage	V <sub>R</sub>	5	V
Reverse Current @5V	I <sub>R</sub>	10	μΑ
Junction Temperature	Tj	115	°C
Operating Temperature	TOPR	-40~+85	°C
Storage Temperature	T <sub>STG</sub>	-40~+100	°C
Soldering Temperature	T <sub>SOL</sub>	260	°C
Thermal Resistance - Junction to Solder Point	R <sub>th</sub>	7	°C/W

 $<sup>^{</sup>f *}$  in the order of Cool White / Warm White

# Electrical & Optical Characteristics (Ta=25°C)

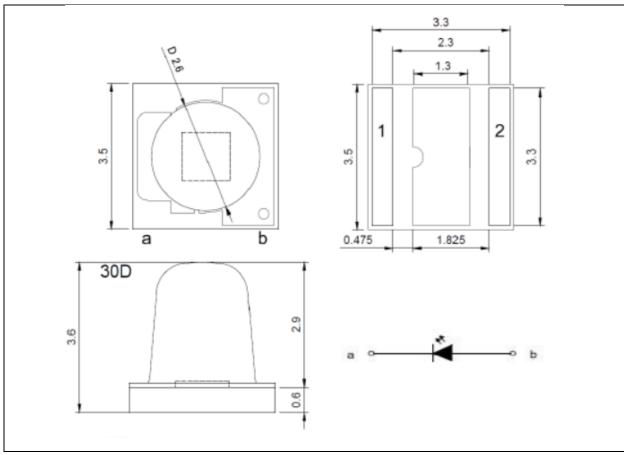
Parameter Symb		Values			Unit	Test
Parameter	Symbol	Min.	Тур.	Max.	Offic	Condition
Forward Voltage	$V_{F}$	1.8		2.6	V	I <sub>F</sub> =350mA
Luminous Flux	Ф۷	50		70	lm	I <sub>F</sub> =350mA
Dominant Wavelength	$\lambda_{D}$	585		595	nm	I <sub>F</sub> =350mA
Viewing Angle	2θ <sub>1/2</sub>		30		deg	I <sub>F</sub> =350mA

<sup>1.</sup> Radiant Flux ( $\Phi_V$ ) ±5%, Forward Voltage ( $V_F$ ) ±0.06V, Viewing angle( $2\theta_{1/2}$ ) ±10°



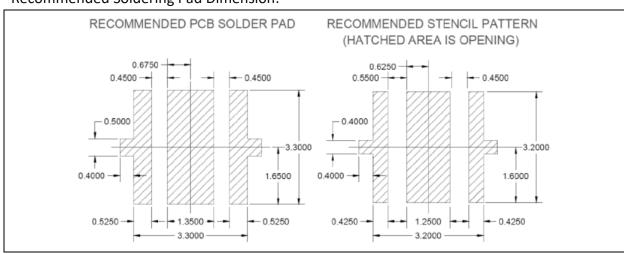
## **OUTLINE DIMENSION:**

## Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.13mm, unless otherwise noted.

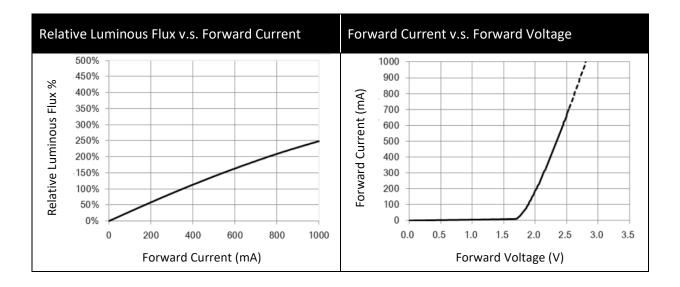
## **Recommended Soldering Pad Dimension:**

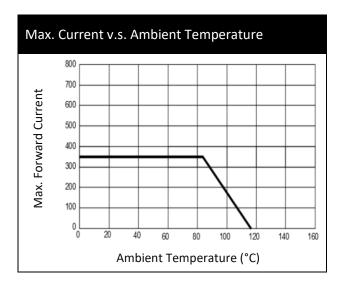


- Dimensions are in millimetre (mm).
- 2. Tolerance ±0.12mm with angle tolerance ±0.5°.



## **ELECTRO-OPTICAL CHARACTERISTICS:**







## **BINNING GROUPS:**

# Forward Voltage Classifications (I<sub>F</sub> = 350mA):

Code	Min.	Max.	Unit
V18	1.8	2.0	
V20	2.0	2.2	W
V22	2.2	2.4	V
V24	2.4	2.6	

## Luminous Flux Classifications (I<sub>F</sub> = 350mA):

Code	Min.	Max.	Unit
Y50	50	55	
Y55	55	60	lina
Y60	60	65	lm
Y65	65	70	

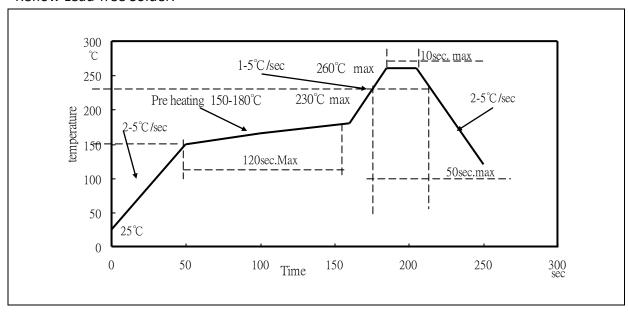
## Dominant Wavelength Classifications (IF = 350mA):

Code	Min.	Max.	Unit
Y1	585	590	2.22
Y2	590	595	nm



## **RECOMMENDED SOLDERING PROFILE:**

## Reflow Lead-free Solder:



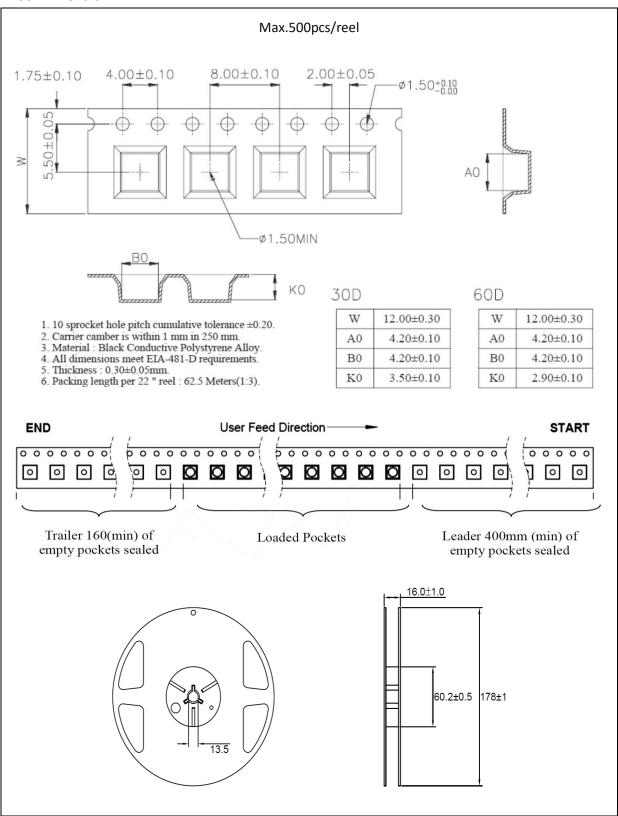
## Note:

- 1. Maxima reflow soldering: 3 times.
- 2. The recommend reflow temperature is 240°C. The maxima soldering temperature should be limited to 260°C.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



## **PACKING SPECIFICATION:**

#### Reel Dimension:





#### **PRECAUTIONS OF USE:**

#### Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

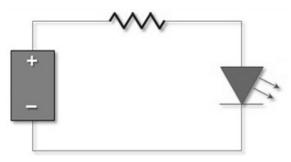
## Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

60±3°C x 24hrs and <5%RH, taped / reel package.</li>

It's normal to see slight color fading of carrier (light yellow) after baking in process.

## **Testing Circuit:**



Must apply resistor(s) for protection (over current proof).

#### Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

## ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



# **REVISION RECORD:**

Version	Date	Summary of Revision
A1.0	17/01/2022	Datasheet set-up.
A1.1	01/02/2025	New datasheet format.